1 **Supplementary Materials** Nanoscale effects of TiO2 nanoparticles on the rheological behaviors of ultra-high molecular 2 3 weight polyethylene (UHMWPE) 4 Yang Sui<sup>a, b</sup>, Yi Cui<sup>a, b</sup>, Chuanbo Cong<sup>a, b</sup>, Xiaoyu Meng<sup>a, b</sup>, Haimu Ye<sup>a, b</sup>, Qiong Zhou<sup>a, b</sup>\* 5 6 7 The mechanism of the surface modification of nano-TiO<sub>2</sub> by KH570 is shown as scheme 1<sup>1</sup>, which is very similar to our previous study<sup>2</sup>. The chemical formula is CH<sub>2</sub>=C(CH<sub>3</sub>)COO(CH<sub>2</sub>)Si(OCH<sub>3</sub>)<sub>3</sub> and 8 its reaction with nano-TiO<sub>2</sub> consists of three steps: (1) the -R group attaches to the silicon atom 9 10 hydrolyzes to form Si-OH oligosiloxane; (2) the Si-OH in oligosiloxane forms a hydrogen bond with the -OH on the surface of nano-TiO<sub>2</sub>; (3) covalent bond with TiO<sub>2</sub> is formed along with dehydration reaction 11 12 during the heating process.



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14 Scheme S1. Mechanism of the surface modification of TiO<sub>2</sub> nanoparticles by KH570 (A stands for

15 CH<sub>2</sub>=C(CH<sub>3</sub>)COO(CH<sub>2</sub>) and R is OCH<sub>3</sub>)

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2 Fig. S1. Size distribution of modified (a) 6-10 nm and (b) 70 nm TiO<sub>2</sub> nanoparticles. TEM morphologies

3 images of modified (c) 6-10 nm and (d) 70 nm nanoparticles.



8 Fig. S2. Guinier approximation plot of pure UHMWPE (a) and the UHMWPE/0.3% TiO<sub>2</sub> composite
9 (b).

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11 The natural logarithm of the equation  $I(q) = I(0)exp(-R_g^2q^2/3)$  [29] is 12  $ln I(q) = lnI(0) - R_g^2q^2/3$ . Then the gyration radius of the sample  $(R_g)$  can be calculated through the 13 slope of Guinier approximation plot, that is Slope  $= -R_g^2/3$ . For pure UHMWPE, 14  $R_g = \sqrt{(-3) \times (-52.65200)} = 12.57$  nm; For UHMWPE/0.3% TiO<sub>2</sub>,  $R_g = \sqrt{(-3) \times (-41.02029)}$ 

- 1 = 11.09 nm.
- 2 References:
- 3 1. J. Liu, J. Yu, M. He and S. Lu, Chinese Journal of Colloid & polymer, 2010, 28, 19-21.
- 4 2. Y. Cui, Y. Sui, P. Wei, Y. Lv, C. Cong, X. Meng, H. Ye and Q. Zhou, Nanomaterials, 2023, 13, 1096.
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